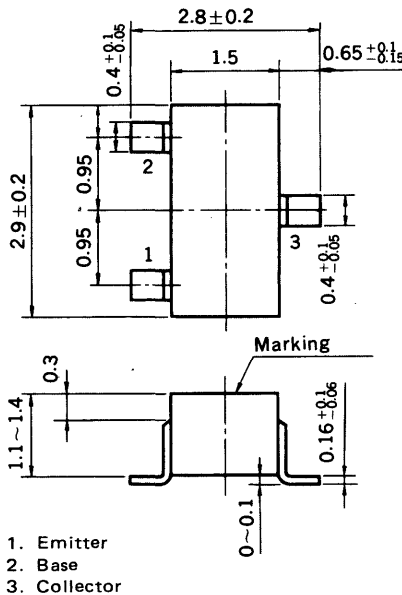


HIGH FREQUENCY AMPLIFIER
NPN SILICON EPITAXIAL TRANSISTOR
MINI MOLD

PACKAGE DIMENSIONS
in millimeters



FEATURES

- High Speed: $t_{stg} < 200$ ns
- Complementary to 2SA1461

ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Current ($T_a = 25^\circ\text{C}$)

Collector to Base Voltage	V_{CB0}	60	V
Collector to Emitter Voltage	V_{CEO}	40	V
Emitter to Base Voltage	V_{EBO}	6	V
Collector Current (DC)	I_C	200	mA

Maximum Power Dissipation

Total Power Dissipation at 25°C Ambient Temperature	P_T	200	mW
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Maximum Temperatures

Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

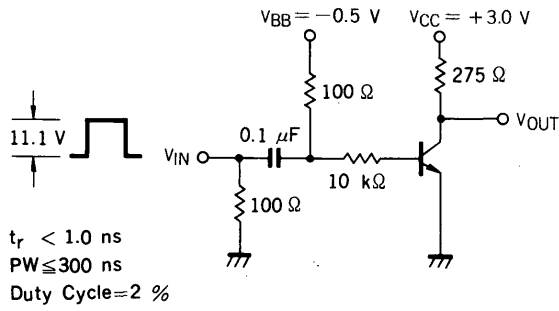
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	I_{CBO}			100	nA	$V_{CB} = 30$ V, $I_E = 0$
Emitter Cutoff Current	I_{EBO}			100	nA	$V_{EB} = 3.0$ V, $I_C = 0$
DC Current Gain	h_{FE1}^*	75	200	300		$V_{CE} = 1.0$ V, $I_C = 10$ mA
DC Current Gain	h_{FE2}^*	25	80			$V_{CE} = 1.0$ V, $I_C = 100$ mA
Collector Saturation Voltage	$V_{CE(sat)}^*$		0.12	0.3	V	$I_C = 50$ mA, $I_B = 5.0$ mA
Base Saturation Voltage	$V_{BE(sat)}^*$		0.80	0.95	V	$I_C = 50$ mA, $I_B = 5.0$ mA
Gain Bandwidth Product	f_T	300	510		MHz	$V_{CE} = 20$ V, $I_E = -10$ mA
Output Capacitance	C_{ob}		3.0	4.0	pF	$V_{CB} = 5.0$ V, $I_E = 0$, $f = 1.0$ MHz
Turn-on Time	t_{on}			70	ns	$V_{CC} = 3.0$ V
Storage Time	t_{stg}		100	200	ns	$I_C = 10$ mA
Turn-off Time	t_{off}			250	ns	$I_{B1} = -I_{B2} = 1.0$ mA

* Pulsed: $PW \leq 350$ μs , Duty Cycle $\leq 2\%$

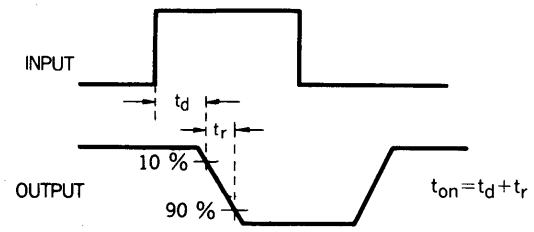
h_{FE} Classification

Marking	B22	B23	B24
h_{FE1}	75 to 150	100 to 200	150 to 300

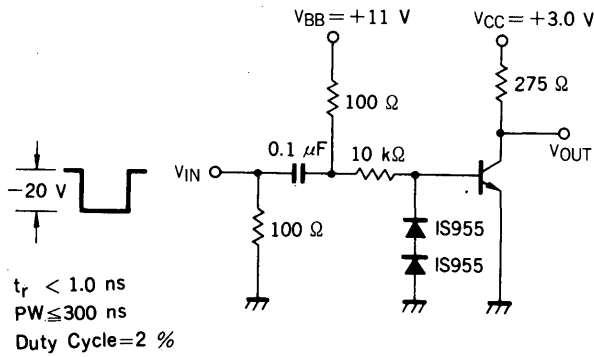
SWITCHING TIME TEST CIRCUIT



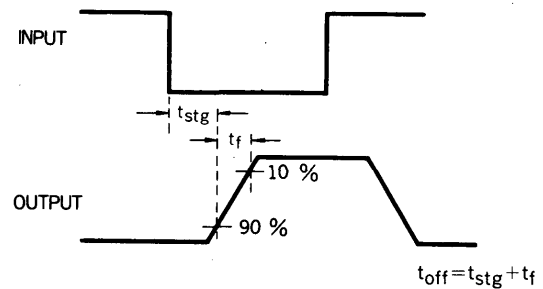
t_{on} SWITCHING



VOLTAGE WAVEFORMS

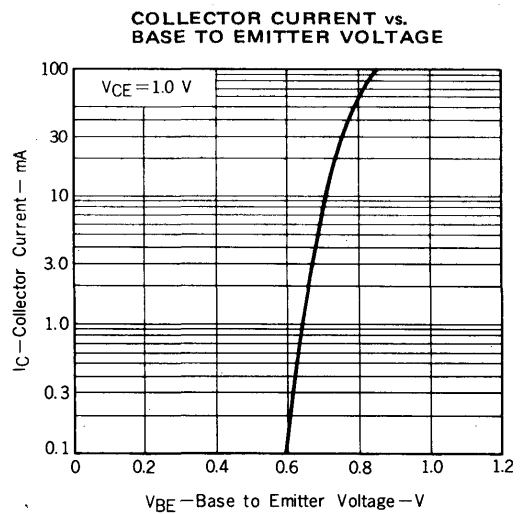
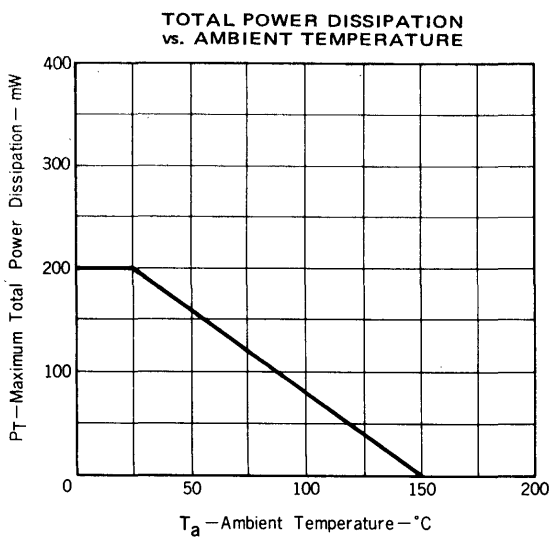


t_{off} SWITCHING

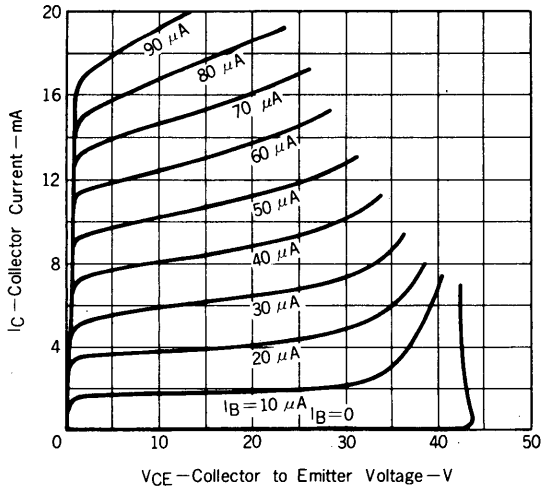


VOLTAGE WAVEFORMS

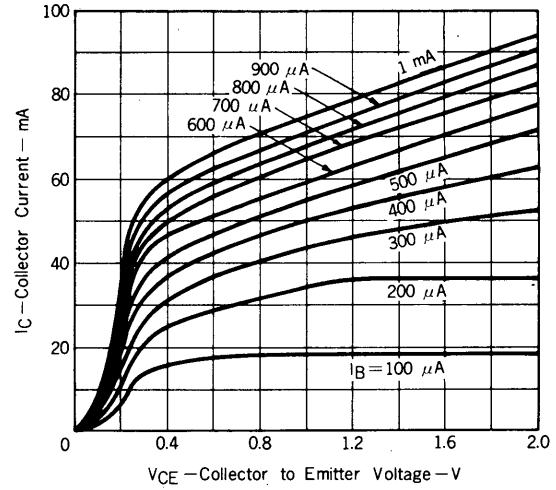
TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)



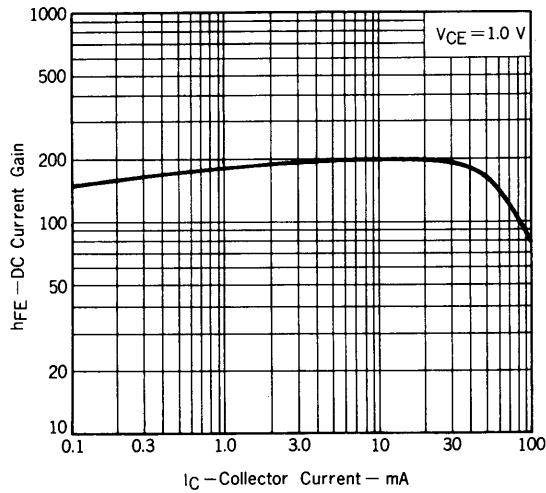
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



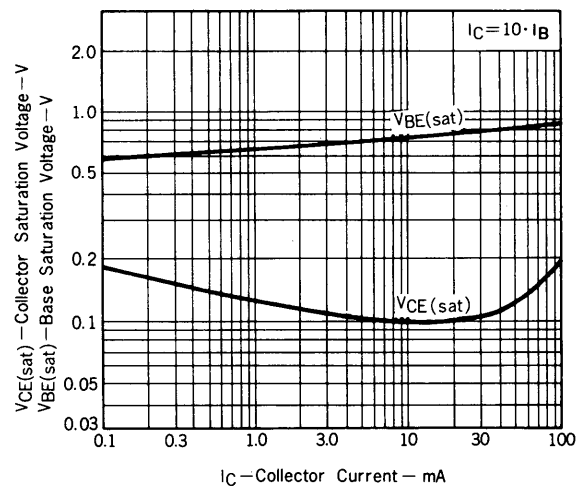
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



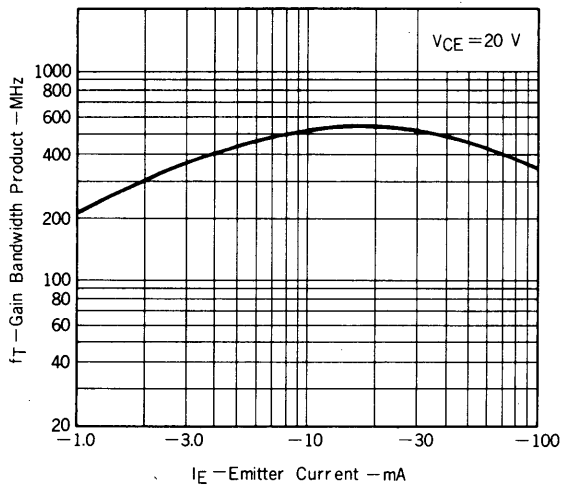
DC CURRENT GAIN vs. COLLECTOR CURRENT



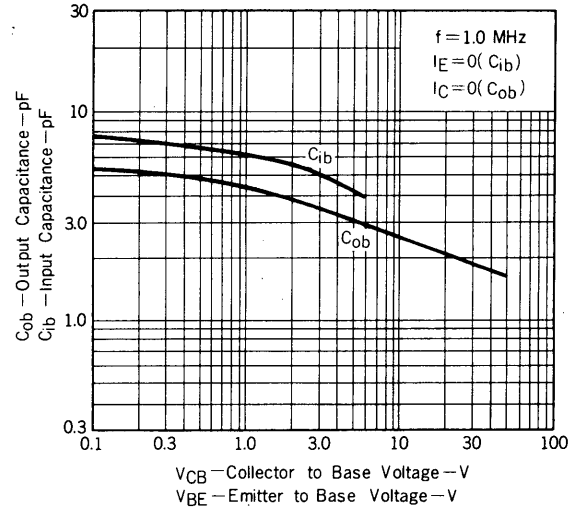
BASE AND COLLECTOR SATURATION VOLTAGE vs. COLLECTOR CURRENT



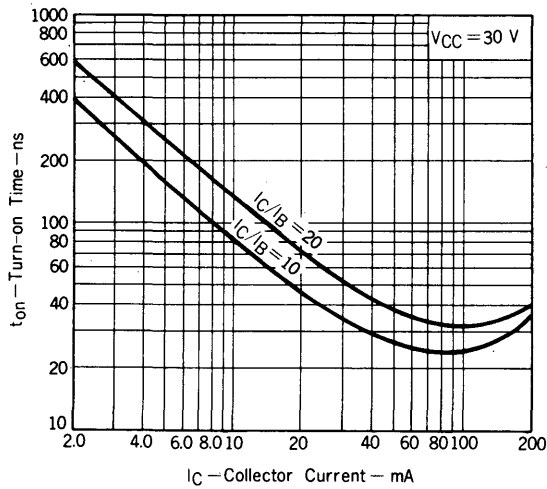
GAIN BANDWIDTH PRODUCT vs. EMITTER CURRENT



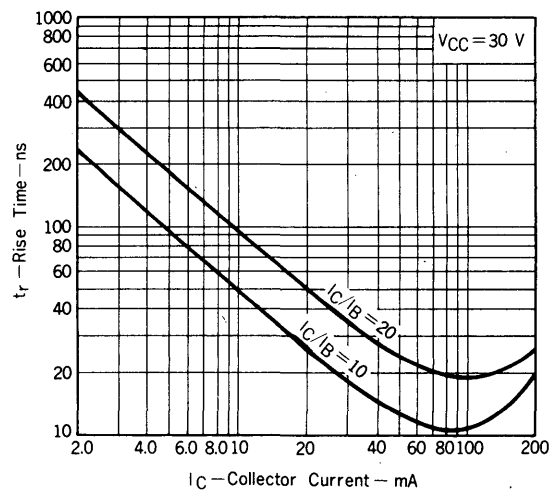
INPUT AND OUTPUT CAPACITANCE vs. REVERSE VOLTAGE



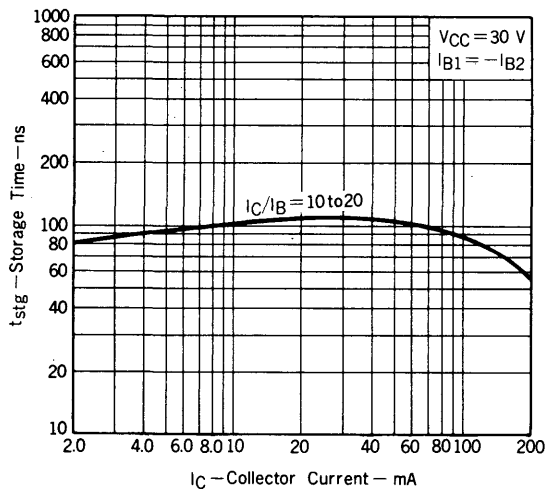
TURN-ON TIME vs. COLLECTOR CURRENT



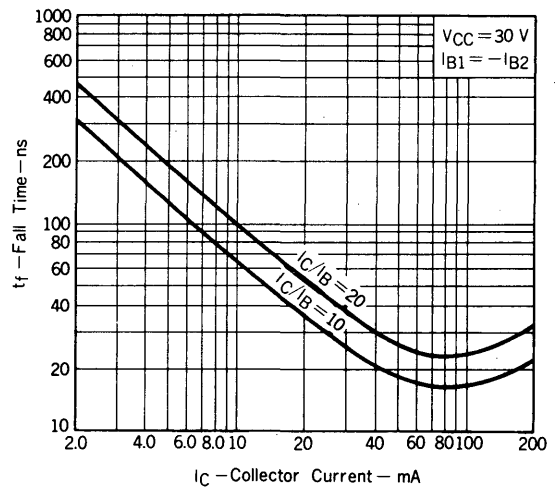
RISE TIME vs. COLLECTOR CURRENT



STORAGE TIME vs. COLLECTOR CURRENT



FALL TIME vs. COLLECTOR CURRENT



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